

# Revolutionary Programming Technology

A revolutionary programming platform delivering managed and secure programming with unrivaled performance at an extraordinary value.



# **Revolutionary Performance**

- ✓ Engineered for ultra fast read/write speeds greater than 160 MBytes/second with TurboBoost
- ✓ 2x faster download speed up to 50 MBytes/second
- ✓ Larger image file size support up to **256GB file** and extensible up to **512GB**

# Architected for managed and secure programming

- ✓ Best-in-class security with LumenX Data Management Software application
- ✓ Comprehensive Traceability Software
- ✓ Secures programming job from point of creation to point of manufacturing

# **Revolutionary Value**

- ✓ Expertly integrated into the PSV7000 and PSV5000 for maximum socket capacity
- ✓ Reduce cost by up to 3x for the lowest total cost per programmed part
- ✓ Global Service and Support

All roadmaps and features are subject to change without notice





#### **Specifications**

Device Support

- eMMC Flash Memory 4.41 5.1 LumenX<sup>™</sup> supports eMMC standard Speed, HS, HS200 and HS400 modes
- SPI NOR
- Universal Flash Storage (UFS)

#### Performance

- Up to 160 MB/sec + read
- Up to 160 MB/sec + write
- Up to 50 MB/sec download

#### File Size Support

• 256GB and extensible up to 512GB

#### **Device Capacity**

• 8 single socket adapter boards per LumenX programmer

#### Network Interface

• 1 Gigabit (1000 BAST-T)

#### Adapter & Socketing Technology

- Standard burn-in sockets (5,000 10,000 insertions per socket)
- High Insertion Count (HIC) for BGA, TSOP, QFP (250,000 insertions per socket)
- Upgrade Kit with UFS Smart Adapter Board for UFS device programming

#### Programming Yield

• 99.5%

#### Changeover

Tool-less

## **Environmental & Regulatory Specification**

Operating Temperature Range

• +10° to +30° C

#### Humidity

≤90%

Regulatory Compliance

- CE
- RoHS

**System Integration** 

**Automated Programming Systems** 

- PSV7000 with AH700
- PSV5000 with CH700

#### Maximum Socket Capacity

- 14 LumenX programmers for up to 112 sockets in PSV7000
- 5 LumenX programmers for up to 40 sockets in PSV5000

#### Value Added Software/Hardware

- Automotive Performance PAK includes
  - Confirm Input Device
  - Tape Label Generator
  - Remote Monitoring
  - Version Control
- Bar Code Scanning
- **Command Line Interface**
- Serialization
- **ConneX™ Smart Programming Software**

#### LumenX Data Management Software (for standard PC interface)

- Role based user authentication to control access to create, modify and run programming jobs
- Version Control
- Read from Master
- Basic Serialization
- LumenX Help

#### **Support Contracts**

The first year of support for factory parts and labor warranty included in purchase price and can be extended via Annual Support Agreement renewal. The APS support program enables access to new & optimized algorithms, system software and LumenX Software updates and hardware support



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# 7000 Velocity. Versatility. Value.

The world's premiere automated programming system with the speed, flexibility and fast changeover to handle any job at the lowest total cost of ownership

**Velocity:** Engineered for speed

**Versatility:** Designed for ultimate flexibility and zero changeover

**Value:** Unprecedented capability, quality & investment protection for existing FlashCORE customers



# When Velocity Matters

- Up to 2000 devices/hour with tray, tape and tube, even with large file sizes
- Optimized system for faster file download
- FlashCORE III
   programmers with
   optimized algorithms
- LumenX programming technology for ultra-fast eMMC programming
- Alignment-on-the-fly
- Zero mechanical changeover

# When Versatility Matters

- Smallest device handling from 1.5 mm x 1.5 mm
- Greatest socket density: scalable up to 24 programmers for up to 96 socket capacity
- Concurrently installed media options
- Dual input tray feeder option
- Ergonomic design for easy access to programmers

# When Value Matters

- Lowest total cost of ownership
- Investment protections for FlashCORE customers' adapters, algorithms, programming Jobs & value added software
- Backed by Data I/O's global service, & support available 24/7
- Local engineering support





# 7000 Velocity. Versatility. Value.

#### **Device Handling System**

- **Throughput:** Up to 2000 devices per hour with tape, tray or tube
- Placement Accuracy: ± .03 mm
- Placement Force: Compliant probe tips, combined with precision placement means the chance for bent pins is virtually eliminated
- Pick-and-Place Method: 2 single vacuum nozzles
- Component Detection: vacuum sensor
- Frame Dimensions: 1250 mm W x 1280 mm D x 1500 mm H (not including media I/O & monitor)
- Shipping Dimensions: 1504 mm W x 1534 mm D x 1754 mm H (not including media I/O)
- □ Net Weight: 350Kg
- Shipping Weight: 500Kg
- Regulatory: CE Compliant, RoHS, WEEE
- Alignment: Alignment-on-the-fly alignment (laser based)
- Component Processing Range: (1.5 mm x 1.5 mm) to (32 mm x 32 mm)

#### **Positioning System**

- **X-Y drive system:** Servo-driven belt drive
- X-Y-axis resolution: ±.001 mm using linear encoders
- □ Theta-axis resolution: .072° servo drive
- X-Y encoder type: linear/rotary dual encoder
- **Z-drive system:** stepper belt-drive
- Theta Drive System: servo motor

#### I/O Media Options

- **Dual Input Tray Feeder** supports up to 20 JEDEC trays and presents two trays of unprogrammed devices into the work envelop. Jobs ending with blank and programmed devices mixed are sorted at the end of the job.
- Dual Input Tray Feeder-EX has an extra tray postion ensuring programmed and blank devices never mix
- Tape-In: Hover Davis Tape-in 8 mm to 56 mm tape-width
- Tape-Out: V-Tek tape out system 8 mm to 56 mm tapewidth
- Tube-In / Out: Available without any special tooling
- Manual Tray: Available without any special tooling

#### **Device Marking Options**

Laser Marker option is modular and integrated into the work envelope

- Laser Marker: Solid-state pulsed fiber laser for alpha-numeric / graphic / 2D bar-code laser marks up to 28 mm x 28 mm mark area
- Power: 10 Watt

#### **Additional Options**

- Vision: 3D Coplanarity Vision System
- **"Vision:** 2D Downward Vision System for faster & easier teach

#### **Programmers**

- FlashCORE III
- LumenX

#### Americas

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System with "gull-wing" style doors open for easy access to work envelop

#### **System Requirements**

- **Air Pressure:** 80 psi (5.5 bar)
- □ Air Flow: 6 SCFM
- **Operational Temperature:** 55° F 90° F
- Input Line Voltage: Singlephase 220V
- Input Line Frequency: 50 60 Hz
- Power Consumption: 1.5 KVA
- Humidity: 35% to 90% RH Non-Condensing

#### Software

- TaskLink for Windows
- AH700
- T ConneXTM
- □ Windows 7

#### **Support Options**

- Operator training
- Annual Programmer Support (APS)

#### **Service Spares**

- PSV7000 Basic Spares Kit
- PSV7000 Supplemental Spares Kit
- PS-FlashCORE III Spares Kit



#### Universal Device Support

• FlashCORE: Flash Memory (NOR, NAND, MCP, MMC, e.MMC, SD, MoviNAND, OneNAND, iNAND, Serial Flash, EEPROM, EPROM and more), Microcontrollers and Logic devices (CPLD, FPGA's, PLD's and more)

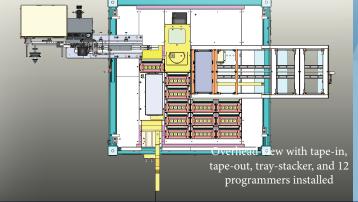
LumenX: eMMC, SD and SPI NOR Flash

#### **Package Support**

• PLCC, SOIC, SON, WSON, SSOP, CSP, (BGA, uBGA and FPGA, QFP, TQFP, TSOP, PoP, DIP and more

#### **Device Testing**

• Continuity, checksum, blank check, misinsertion test, verify, backwards device, two pass verify







# Efficient. Reliable. Affordable.

The PSV5000 is the cost effective entry point for high performance automated device programming. The PSV5000 delivers trusted performance, flexibility & reliability at an affordable price.



# **Efficient**

Designed for optimum performance & flexibility in a compact footprint

# Fast programming with easy changeover

- up to 1300 parts/hour
- Scalable 1-6 FlashCORE III programmers (4 to 24 sockets)
- Scalable 1 to 5 LumenX programmers (1 to 40 sockets)
- Ideal for first time automation customers

## **✓** Flexibile Options

- Integrated media options
- Fiber laser marking
- Small parts down to 2 mm x 3 mm
- Large parts up to 42.5 mm x 42.5 mm
- Optimized Algorithms & Universal Device Support

# Reliable

Engineered for highest quality programming, uptime & production yield

## Highest quality programming results

- HIC adapters for highest programming yield
- Value added software

# ✓ Intelligent system design & integration

 Proven pick & place head, programming engine & handling software

# ✓ Integrated vision system for precise placement

- +/- 30 micron for repeatable precision placement
- Support for small parts

# **Affordable**

Developed to deliver high quality automated programming for the lowest cost per programmed device

## ✓ Lowest Total Cost

- Significantly reduce labor cost
- Save >3x cost per programmed part
- Maximum socket density in a compact system minimizes floor space and enables quick scaling as production ramps

#### ✓ Investment Protection

- Works with existing FlashCORE adapters & algorithms
- Growing support for LumenX ensures your investment is protected now and in the future

## ✓ Global Service & Support

- Local service, engineering & support
- Regional spare parts





# Efficient. Reliable. Affordable.

**Device Handling System** 

**Throughput:** Handler rated up to 1300 devices per hour

**Placement Accuracy:** ±.02mm

Pick-and-Place Method: Single-probe stepper actuated z-motion with **Shipping Dimensions:** 

servo-drive theta (rotation axis)

Probe Stroke: 50 mm (max)

Alignment: Upward looking camera **Regulatory Compliance:** CE Compliant, RoHs, WEEE

System Software: TaskLink for Windows, CH700, Windows 7 **Dimensions:** 

1290mm D x 870mm W x 1520mm H (not including media I/O & monitor)

1310mm D x 930mm W x 1760mm H (not including media I/O & monitor)

Net Weight: 450kg (992 lbs) 550kg (1212lbs) Shipping Weight:

#### I/O Media Options

Any combination of input/output media I/O

12 mm - 56 mm Tape Input:

8 mm - 44 mm (adjustable) Tape Output:

• Tray feeder Input/Output: Supports up to 20 JEDEC Trays

• Manual Tray: Available without any special tooling

Tube Input and Output

Reject bin

## **Device Marking Option**

Laser Marker: Fiber laser marking

0 - 10 Watts Power:

#### Value Added Software

- **Serial Number Server**
- Automotive Performance PAK
- NAND Flash Bad Block Management
- Data Management Software Suite (LumenX only)
- ConneX<sup>™</sup>Smart Programming Software

#### Support Options & Service Spares

- PSV5000 Basic Spares Kit
- PSV5000 Supplemental Spares Kit
- PS- FlashCORE III Spares Kit
- Operator training
- Extended Service Contracts: The first year of support is included in the system purchase price and can be extended via extended service support renewal. Data I/O offers a suite of options to covers both hardware and system software (consumables are not included).

## **Programming Engine, Adapters & Device Support**

#### Programmer

- FlashCORE III with SuperBoost Technology
- Lumen™X technology

#### Socketing Technology

- **Standard burn-in sockets** (typically 5,000 10,000 insertions per socket)
- High Insertion Count Sockets (HIC) for BGA, TSOP, QFP (typically 250,000 insertions per socket)

#### Universal Device Support

FlashCORE III: Flash Memory (NOR, NAND, MCP, MMC, e.MMC, SD, MoviNAND, OneNAND, iNAND, Serial Flash, EEPROM, EPROM and more), Microcontrollers and Logic devices (CPLD, FPGA's, PLD's) and more

**LumenX:** eMMC, SD and SPI NOR with support for additional device technologies in process

#### Package Support

 PLCC, SOIC, SON, WSON, SSOP, CSP, BGA, uBGA and FPGA, QFP, TQFP, TSOP, PoP. DIP and more

#### Device Programming & Testing

Program, continuity, checksum, blank check, mis-insertion, test, verify, backwards device, two pass verify, ID check, Illegal bit-check

## Requirements

Electrical/Power

Input voltage: 208 - 240 VAC, 50/60 Hz, 1 PHz

• 10 Amps Max

Compressed Air Usage **Air pressure:** 80psi (5.5 bar) • Air flow: 6 SCFM (max)

Operatering Temperature

•  $55^{\circ}$ F to  $86^{\circ}$ F (+13°C to + 30°C)

Humidity

• 35% to 90% RH Non-Condensing



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